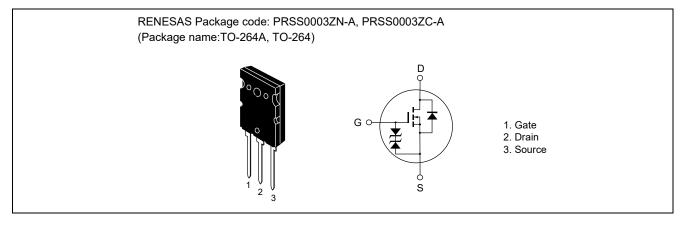


500V - 40A - MOS FET High Speed Power Switching R07DS1196EJ0200 Rev.2.00 Feb.4.2022

Features

- Low on-resistance
 - $R_{DS(on)} = 0.12 \Omega$ typ. (at I_D = 20 A, V_{GS} = 10 V, Ta = 25°C)
- High speed switching
- Low drive current
- Suitable for switching regulator and DC-DC converter
- Quality grade: Standard

Outline



Absolute Maximum Ratings

(Ta = 25 °C)

			(14 20 0)
Item	Symbol	Ratings	Unit
Drain to source voltage	Vdss	500	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	lD	40	A
Drain peak current	I _{D(pulse)} Notes1	160	A
Body-drain diode reverse drain current	I _{DR}	40	A
Channel dissipation	Pch Notes2	250	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for Handling and Usage of Semiconductor Devices) and individual reliability data.

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25 °C



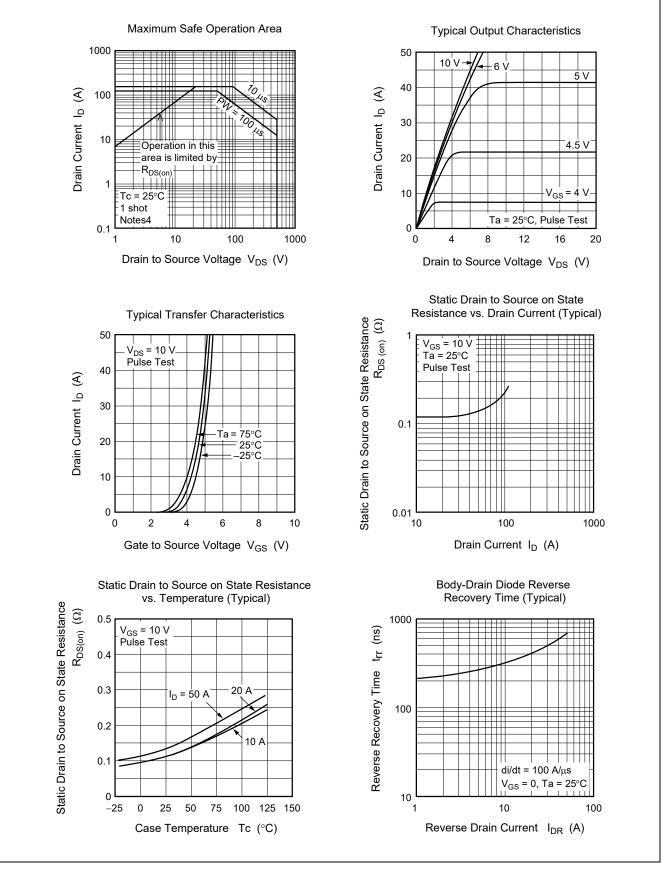
Electrical Characteristics

						(Ta = 25 °C)
ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	500	—	_	V	I _D = 10 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±30	—	_	V	$I_{G} = \pm 100 \ \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μA	V_{GS} = ±25 V, V_{DS} = 0
Zero gate voltage drain current	IDSS	_	—	250	μA	V _{DS} = 400 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	2.0		3.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state resistance	R _{DS(on)}	_	0.12	0.16	Ω	I_D = 20 A, V_{GS} = 10 V Notes3
Forward transfer admittance	y _{fs}	20	30	—	S	I _D = 20 A, V _{DS} = 10 V ^{Notes3}
Input capacitance	Ciss		5800		pF	V _{DS} = 10 V
Output capacitance	Coss	_	1430		pF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	_	150		pF	
Turn-on delay time	t _{d(on)}	_	60	_	ns	I _D = 20 A
Rise time	tr	_	175	_	ns	V _{GS} = 10 V R _L = 1.5 Ω
Turn-off delay time	t _{d(off)}	_	420	_	ns	
Fall time	tr		160		ns	
Body-drain diode forward voltage	VDF		1.2		V	I _F = 40 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}	_	600	—	ns	I _F = 40 A, V _{GS} = 0 di _F /dt = 100 A/μs

Notes: 3. Pulse test

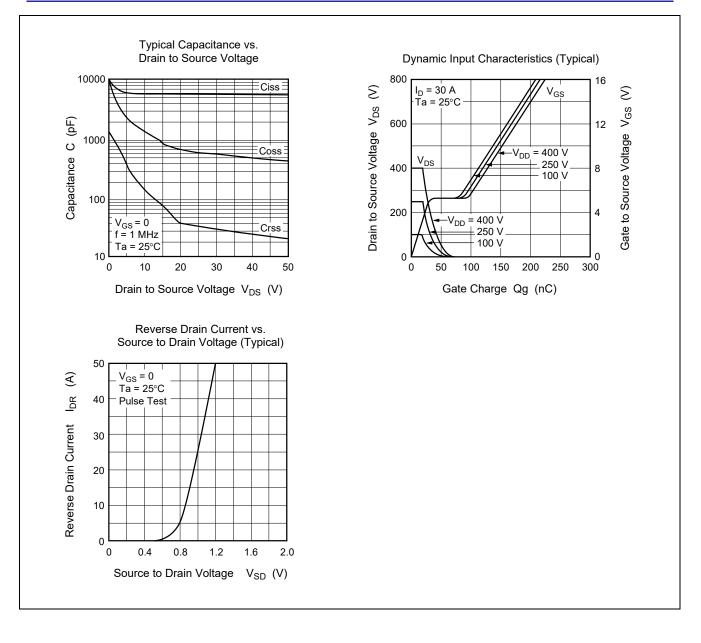


Main Characteristics

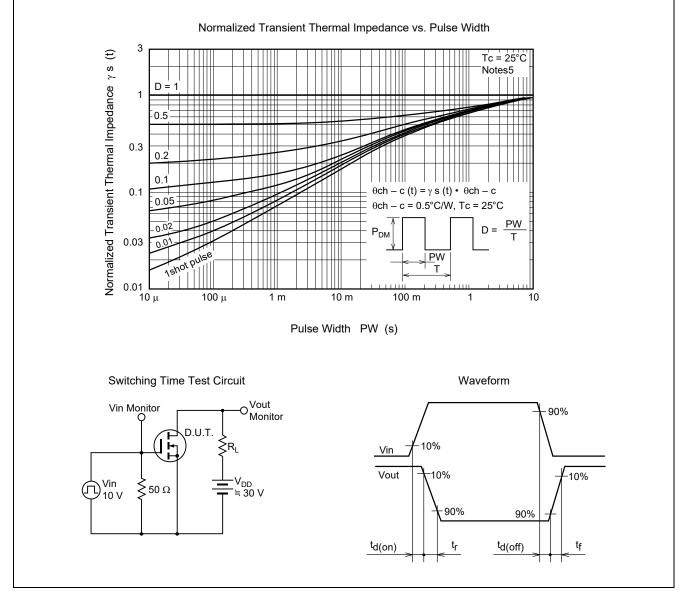


Notes: 4. Designed target value on Renesas measurement condition. (Not tested) Renesas recommends that operating conditions are designed according to a document "Power MOS FET • IGBT Attention of Handling Semiconductor Devices".









Notes: 5. Designed target value on Renesas measurement condition. (Not tested)

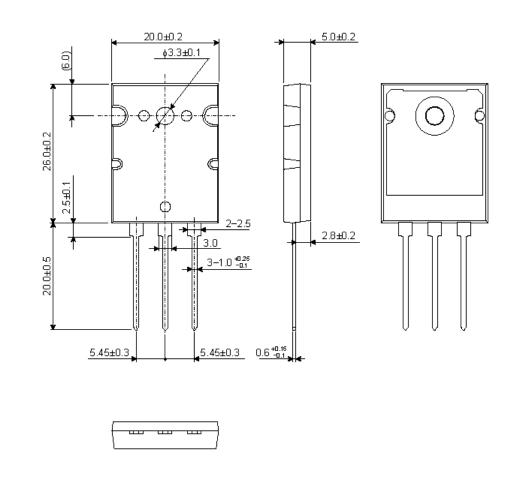


Package Dimensions

ASSEMBLED IN CHINA

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
TO-264A	—	PRSS0003ZN-A	TO-264A	9.7

Unit: mm



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ASSEMBLED IN KOREA

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	
TO-264	—	PRSS0003ZC-A	TO-264S	9.48g	Unit: mm
		$ \begin{array}{c} 20.0 \pm 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\$	¢3.2 ± 0.2	5.0 ± 0.2	

Ordering Information

Orderable Part No.	Quantity	Shipping Container
2SK1527-E1-E#T2	25 pcs	Tube



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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

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